

#### OSTB1010C4C-A

#### **■Features**

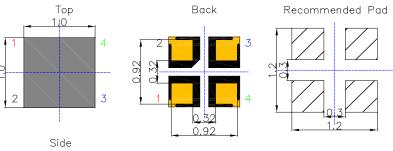
- Full-color RGB LED
- Super high brightness of surface mount LED
- Black diffused flat mold
- Compact package outline
   (LxWxT) of 1.0mm x 1.0mm x 0.9mm
- Compatible to IR reflow soldering.

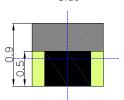
## **■**Applications

Backlighting (switches, keys, etc.)

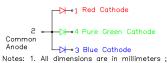
Marker lights (e.g. steps, exit ways, etc.)

#### **■Outline Dimension**





(Ta=25°C)

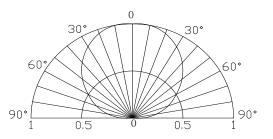


Notes: 1. All dimensions are in millimeters; 2. Tolerance is  $\pm$  0.20 mm unless otherwise noted.

### ■Absolute Maximum Rating

Item	Symbo	Val	Unit	
Itelli	1	HR	PG/BL	Ollit
DC Forward Current	$I_F$	20	20	mA
Pulse Forward Current#	$I_{FP}$	100	100	mA
Reverse Voltage	$V_R$	5	5	V
Power Dissipation	$P_{D}$	46	66	mW
Operating Temperature	Topr	-40 ~	°C	
Storage Temperature	Tstg	-40~	°C	
Lead Soldering Temperature	Tsol	260°C/	-	

## **■**Directivity



#Pulse width Max 0.1ms, Duty ratio max 1/10

### **■**Electrical -Optical Characteristics

## (Ta=25°C)

			$V_{F}(V)$		$I_R(\mu A)$	Iv(mcd)		λD(nm)			2θ1/2(deg)			
Part Number	Color		Min.	Тур.	Max.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.	
				I <sub>F</sub> =5mA		$V_R=5V$	I <sub>F</sub> =5mA							
	Blue	BL		-	2.7	3.3	10	30	-	50	465	470	475	120
OSTB1010C4C-A	Pure Green	PG		-	2.7	3.3	10	100	-	500	520	525	530	120
	Red	HR		-	1.7	2.3	10	60	-	80	615	620	625	120

<sup>\*1</sup> Tolerance of measurements of dominant wavelength is ±1nm

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<sup>\*2</sup> Tolerance of measurements of luminous intensity is ±15%

<sup>\*3</sup> Tolerance of measurements of forward voltage is  $\pm 0.1$ V

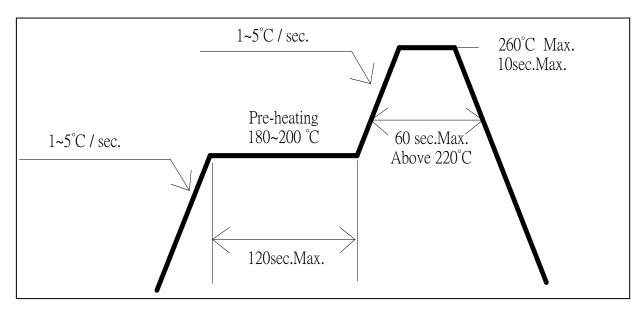


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### **■** Soldering Conditions

	Reflow Soldering	Hand Soldering			
Pre-Heat	180 ~ 200°C				
Pre-Heat Time	120 sec. Max.				
Peak temperature	260°C Max.	Temperature	350°C Max.		
Dipping Time	10 sec. Max.	Soldering time	3 sec. Max.		
Condition	Refer to Temperature-profile		(one time only)		

#### • Reflow Soldering Condition(Lead-free Solder)



- \*Recommended soldering conditions vary according to the type of LED
- \*Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- \*A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.





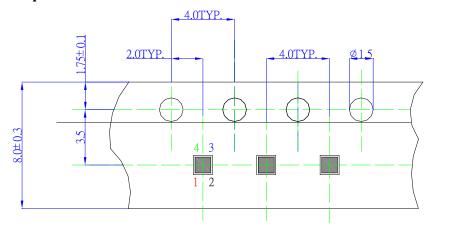


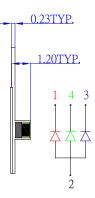




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## **■** Reel & Tape Dimensions





#### Notes:

- 1. Unit: mm
- 2. 24000pcs/Reel











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#### **■** Cautions:

- 1. After open the package, the LED´s floor life is 4 Weeks under 30℃ or less and 60%RH or less(MSL:2a).
- 2. Heat generation must be taken into design consideration when using the LED.
- 3. Power must be applied resistors for protection, over current would be caused the optic damage to the devices and wavelength shift.
- 4. Manual tip solder may cause the damage to Chip devices, so advised that heat of iron should be lower than 15W with temperature control under 5 seconds at 230-260 deg. C. (The device would be got damage in re working process, recommended under 5 seconds at 230-260 deg. C)
- 5. All equipment and machinery must be properly grounded. It is recommended to use a wristband or anti-electrostatic glove when handing the LED.
- 6. Use IPA as a solvent for cleaning the LED. The other solvent may dissolve the LED package and the epoxy, Ultrasonic cleaning should not be done.
- 7. Damaged LED will show unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LED get unlight at low current.

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